

Data sheet acquired from Harris Semiconductor SCHS041D - Revised October 2003

CMOS Quad 3-State R/S Latches

High-Voltage Types (20-Volt Rating) Quad NOR R/S Latch - CD4043B Quad NAND R/S Latch - CD4044B

■CD4043B types are quad crosscoupled 3-state CMOS NOR latches and the CD4044B types are quad cross-coupled 3state CMOS NAND latches. Each latch has a separate Q output and individual SET and RESET inputs. The Q outputs are controlled by a common ENABLE input, A logic "1" or high on the ENABLE input connects the latch states to the Q outputs. A logic "0" or low on the ENABLE input disconnects the latch states from the Q outputs, resulting in an open circuit condition on the Q outputs. The open circuit feature allows common busing of the outputs.

The CD4043B and CD4044B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line packages (E suffix), 16-lead small-outline packages (D, DR, DT, DW, DWR, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

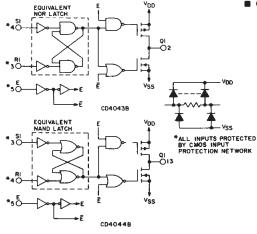


Fig. 1 — Logic diagrams.

MA

CD4043B, CD4044B Types

Features:

- 3-state outputs with common output **ENABLE**
- Separate SET and RESET inputs for
- **NOR and NAND configurations**
- 5-V, 10-V, and 15-V parametric ratings
- Standardized symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package temperature range): $1 \text{ V at V}_{DD} = 5 \text{ V}$

2 V at V_{DD} = 10 V 2.5 V at V_{DD} = 15 V

■ Meets all requirements of JEDEC Tentative Standard No. 138, "Standard Specifications for Description of 'B' Series CMOS Devices'

Applications:

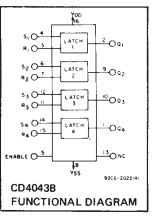
- Holding register in multi-register system
- Four bits of independent storage with output ENABLE
- Strobed register
- General digital logic

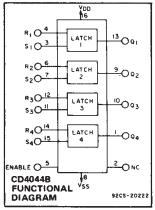
ENABLE

R2 -

Vss.

- CD4643B for positive logic systems
- CD4044B for negative logic systems







CD4044B

0 OC.

SRE ٥

TERMINAL ASSIGNMENTS

	s	R	E	Q
		Х	0	oc.
	0	0	1	NC+
	1	0	1	1
	0	1	1	0
	1	1	1	I∆
*OPEN CIR				
+ NO CHAI	VGE			
△ DOMINA	TEC	B	/ S=	1 INPUT

- 54

- S3

- 03

9205-2447681

X X 1 1 0 1 1 0 0 0 OPEN CIRCUIT + NO CHANGE △ △ DOMINATED BY R=O INPUT

CD4044B

TRUTH TABLES

Recommended Operating Conditions TA=25°C For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

Characteristic **	V _{DD} (V)	Min.	Max.	Units
Supply-Voltage Range (T _A = Full Package Temperature Range)	1	3	18	v
SET or RESET Pulse Width, t _W	5 10 15	160 80 40	- -	ns

NC=NO CON				R	_		
CD4043B							
	S	R	E	Q			
	X	Х	0	oc.			
	0	0	1	NC+			
	1	0	1	1			
	0	1	1	0			
	1	1	1	I∆			
*OPEN CIF	RCU	IT					

CD4043B

TOP VIEW

IAXIMUM RATINGS, Absolute-Maximum Values:
C SUPPLY-VOLTAGE RANGE, (V _{DD})
Voltages referenced to VSS Terminal)0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS-0.5V to V_{DD} +0.5V POWER DISSIPATION PER PACKAGE (PD): For T_A = +100°C to +125°C...... Derate Linearity at 12mW/°C to 200mW **DEVICE DISSIPATION PER OUTPUT TRANSISTOR** OPERATING-TEMPERATURE RANGE (TA).....-55°C to +125°C

STORAGE TEMPERATURE RANGE (T_{stg}).....-65°C to +150°C LEAD TEMPERATURE (DURING SOLDERING):

STATIC ELECTRICAL CHARACTERISTICS

CHARACTER-	COND	HOITION		LIMITS AT INDICATED TEMP					PERATURES (°C)				
	Vo (V)	VIN (V)	V _{DD} (V)	-55	-40	+85	+125	Min.	Typ.	Max.			
Quiescent Device	_	0,5	5	1	1	30	30	_	0.02	1	μΑ		
Current,	_	0,10	10	2	2	60	60 '	-	0.02	2			
IDD Max.	_	0,15	15	4	4	120	120	-	0.02	4			
	- 1	0,20	20	20	20	600	600	_	0.04	20			
Output Low	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	-			
(Sink) Current	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	_			
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	_			
Output High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	_	mA		
(Source)	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	-			
Current,	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	_			
IOH Min.	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	_			
Output Voltage:	-	0,5	5		0	.05	-	1	0	0.05			
Low-Level,	-	0,10	10		0	.05		_	0	0.05	٧		
VOL Max.		0,15	15		0	.05		-	0	0.05			
Output Voltage:	-	0,5	5	1	4	.95	'	4.95	5	-			
High-Level,	_	0,10	10		9	.95		9.95	10	_			
VOH Min.	_	0,15	15		14	1.95		14.95	15	-			
Input Low	0.5, 4.5	-	5		,	1.5			-	1.5			
Voltage,	1, 9	_	10			3				3			
V _{IL} Max.	1.5,13.5		15			4		_		4	V		
Input High	0.5, 4.5	_	5			3.5		3.5					
Voltage,	1, 9		10			7		7					
VIH Min.	1.5, 3.5	_	15			11		11		_			
Input Current IJN Max.	_	0,18	18	±0.1	±0.1	±1	±1		±10-5	±0.1	μΑ		
3-State Output Leakage Current IOUT Max.	0,18	0,18	18	±0.4	±0.4	±12	±12	_	±10-4	±0.4	μΑ		

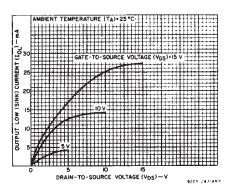


Fig. 2 — Typical output low (sink) current characteristics.

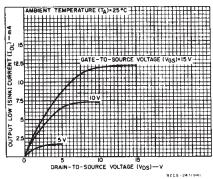


Fig. 3 — Minimum output low (sink) current characteristics.

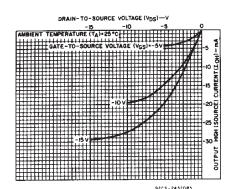


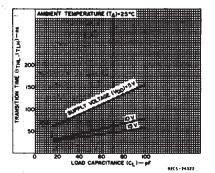
Fig. 4 — Typical output high (source) current characteristics.

CD4043B, CD4044B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at T_A = 25° C; Input t_r , t_f = 20 ns, C_L = 50 pF, R_L = 200 K Ω

CHARACTERISTIC	V _{DD}	ALI	UNITS		
	(V)	TYP.	MAX.		
Propagation Delay	5	150	300	1	
Time: tpHL, tpLH	10	70	140	ns	
SET or RESET to Q	15	50	100		
3-State Propagation Delay	5	115	230		
Time: ENABLE to Q	10	55	110	ns	
^t PHZ ^{, t} PZH	15	40	80		
	5	90	180		
tpLZ, tpZL	10	50	100	ns	
	15	35	70		
Transition Time:	5	100	200		
tTHL, tTLH	10	50	100	ns	
	15	40	80	1	
Minimum	5	80	160		
SET or RESET	10	40	80	ns	
Pulse Width, t _W	15	20	40		
Input Capacitance, (Any Input) C _{IN}		5	7.5	pF	

Fig. 5 — Minimum output high (source) current characteristics.



TEST CIRCUITS

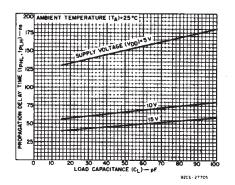


Fig. 7 — Typical propagation delay time vs. load capacitance—SET, RESET to Q, Q.

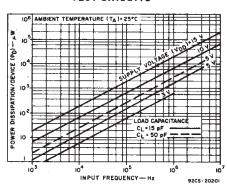


Fig. 8 — Typical power dissipation vs. frequency.

Fig. 6 — Typical transition time vs. load capacitance.

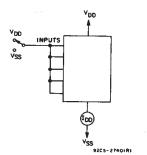


Fig. 9 - Quiescent device current.

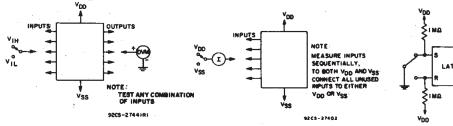


Fig. 10 - Input voltage.

Fig. 11 - Input current.

VOD

S Q OUTPUT

S A OUTPUT

CD4044B

CD4043B

925-27707

Fig. 12 - Switch bounce eliminator.

CD4043B, CD4044B Types

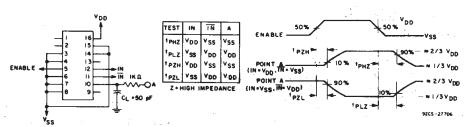
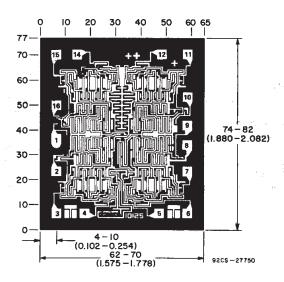
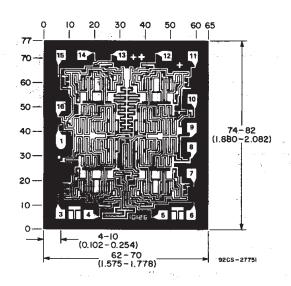


Fig. 13 - ENABLE propagation delay time test circuit and waveforms.

CHIP DIMENSIONS AND PAD LAYOUTS



CD4043BH



CD4044BH

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3}) inch).

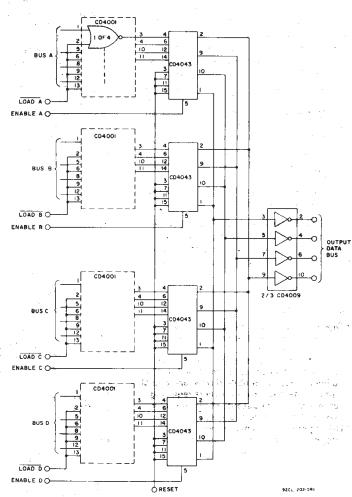


Fig. 14 - Multiple bus storage.





28-Feb-2005

PACKAGING INFORMATION

Ord	erable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
(CD4043BD	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
С	D4043BDR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
C	:D4043BDT	ACTIVE	SOIC	D	16	250	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
С	D4043BDW	ACTIVE	SOIC	DW	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
CE	04043BDWR	ACTIVE	SOIC	DW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
(CD4043BE	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
С	D4043BF3A	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
(CD4043BM	OBSOLETE	SOIC	D	16		None	Call TI	Call TI
CI	D4043BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
С	D4043BPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CI	04043BPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
(CD4044BD	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
С	D4044BDR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
C	D4044BDT	ACTIVE	SOIC	D	16	250	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
С	D4044BDW	ACTIVE	SOIC	DW	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
CE	04044BDWR	ACTIVE	SOIC	DW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
(CD4044BE	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
(CD4044BF	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
С	D4044BF3A	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
(CD4044BM	OBSOLETE	SOIC	D	16		None	Call TI	Call TI
CI	D4044BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
С	D4044BPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CE	04044BPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

(1) The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.



PACKAGE OPTION ADDENDUM

28-Feb-2005

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

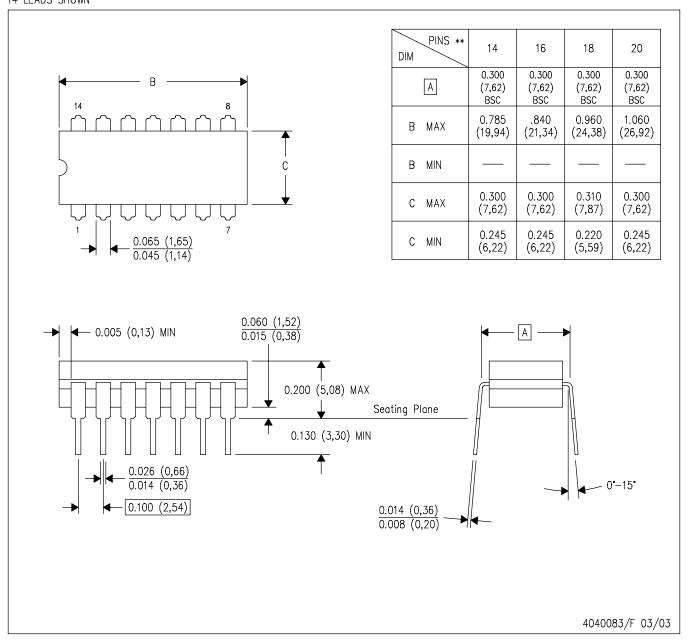
Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

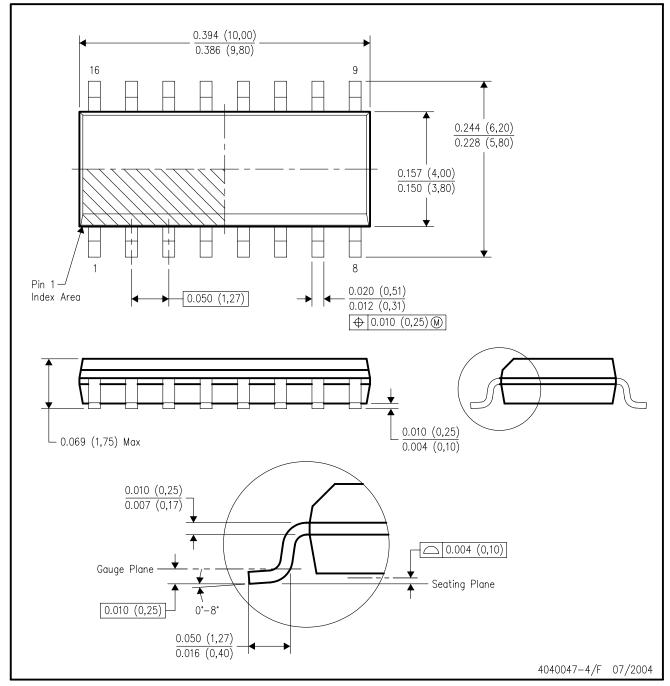


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE

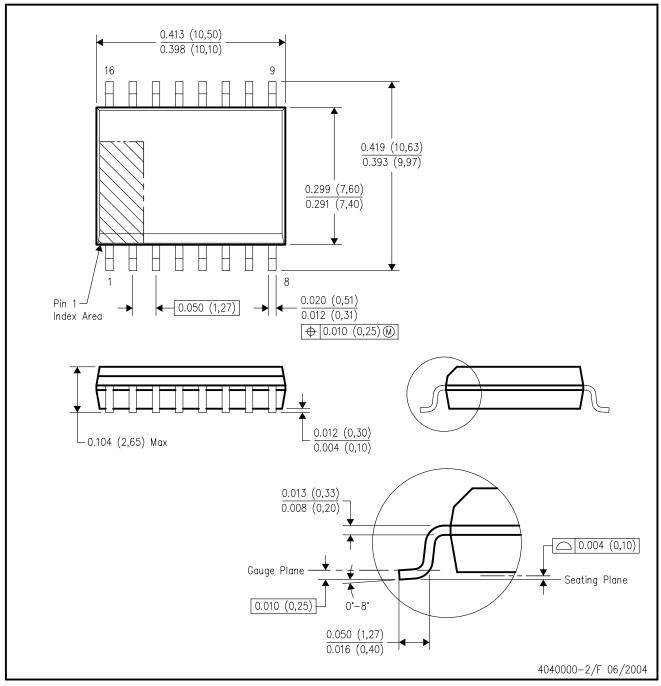


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



DW (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AA.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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CD4043B - http://www.ti.com/product/cd4043b?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4043BM - http://www.ti.com/product/cd4043bm?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044BPWR - http://www.ti.com/product/cd4044bpwr?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4043BNSR - http://www.ti.com/product/cd4043bnsr?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044BDR - http://www.ti.com/product/cd4044bdr?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4043BPW - http://www.ti.com/product/cd4043bpw?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4043BF3A - http://www.ti.com/product/cd4043bf3a?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044BDT - http://www.ti.com/product/cd4044bdt?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4043BPWR - http://www.ti.com/product/cd4043bpwr?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044B - http://www.ti.com/product/cd4044b?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044BD - http://www.ti.com/product/cd4044bd?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4043BD - http://www.ti.com/product/cd4043bd?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044BDW - http://www.ti.com/product/cd4044bdw?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4043BDR - http://www.ti.com/product/cd4043bdr?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4043BE - http://www.ti.com/product/cd4043be?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044BDWR - http://www.ti.com/product/cd4044bdwr?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4043BDW - http://www.ti.com/product/cd4043bdw?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044BE - http://www.ti.com/product/cd4044be?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4043BDWR - http://www.ti.com/product/cd4043bdwr?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044BF - http://www.ti.com/product/cd4044bf?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044BF3A - http://www.ti.com/product/cd4044bf3a?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4043BDT - http://www.ti.com/product/cd4043bdt?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044BPW - http://www.ti.com/product/cd4044bpw?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044BNSR - http://www.ti.com/product/cd4044bnsr?HQS=TI-null-null-dscatalog-df-pf-null-wwe CD4044BM - http://www.ti.com/product/cd4044bm?HQS=TI-null-null-dscatalog-df-pf-null-wwe